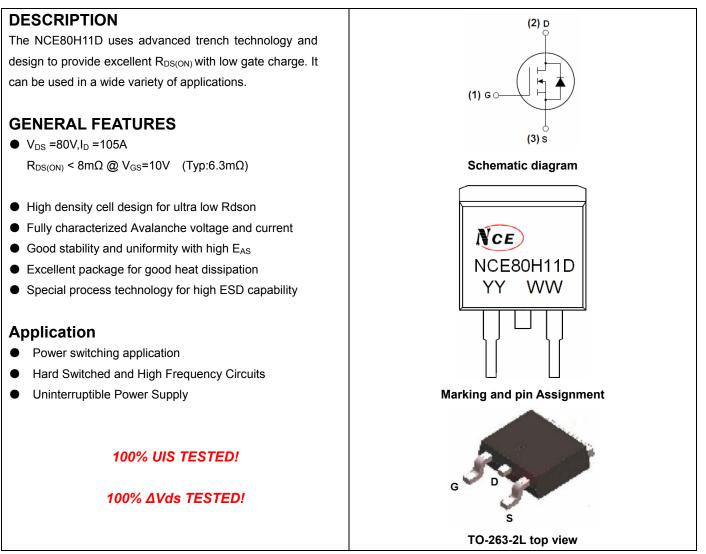


# NCE80H11D

## NCE N-Channel Enhancement Mode Power MOSFET



#### Package Marking And Ordering Information

Device Marking	Device	Device Package	Reel Size	Tape width	Quantity
NCE80H11D	NCE80H11D	TO-263-2L	-	-	-

#### Absolute Maximum Ratings (TA=25°C unless otherwise noted)

Parameter	Symbol	Limit	Unit	
Drain-Source Voltage	Vds	80	V	
Gate-Source Voltage	V <sub>GS</sub>	±20	V	
Drain Current-Continuous	I <sub>D</sub>	105	A	
Drain Current-Continuous(T <sub>C</sub> =100℃)	I <sub>D</sub> (100℃)	80	А	
Pulsed Drain Current	I <sub>DM</sub>	420	А	
Maximum Power Dissipation	PD	200	W	
Derating factor		1.33	W/℃	
Single pulse avalanche energy (Note 5)	E <sub>AS</sub>	800	mJ	



Pb Free Product

NCE80H11D

Operating Junction and Storage Temperature Range	$T_{J},T_{STG}$	-55 To 175	°C

#### **Thermal Characteristic**

I nermal Resistance, Junction-to-Case(Note 2) R <sub>BJC</sub> 0.75 C/W
---

### Electrical Characteristics (TA=25°C unless otherwise noted)

Parameter	Symbol	Condition	Min	Тур	Max	Unit
Off Characteristics						
Drain-Source Breakdown Voltage	BV <sub>DSS</sub>	V <sub>GS</sub> =0V I <sub>D</sub> =250µA	80	86	-	V
Zero Gate Voltage Drain Current	I <sub>DSS</sub>	V <sub>DS</sub> =80V,V <sub>GS</sub> =0V	-	-	1	μA
Gate-Body Leakage Current	I <sub>GSS</sub>	V <sub>GS</sub> =±20V,V <sub>DS</sub> =0V	-	-	±100	nA
On Characteristics (Note 3)		·				
Gate Threshold Voltage	V <sub>GS(th)</sub>	V <sub>DS</sub> =V <sub>GS</sub> ,I <sub>D</sub> =250µA	2	3	4	V
Drain-Source On-State Resistance	R <sub>DS(ON)</sub>	V <sub>GS</sub> =10V, I <sub>D</sub> =40A	-	6.3	8	mΩ
Forward Transconductance	<b>g</b> fs	V <sub>DS</sub> =25V,I <sub>D</sub> =40A	80	-	-	S
Dynamic Characteristics (Note4)		·				
Input Capacitance	C <sub>lss</sub>		-	4900	-	PF
Output Capacitance	Coss	V <sub>DS</sub> =25V,V <sub>GS</sub> =0V, F=1.0MHz	-	410	-	PF
Reverse Transfer Capacitance	C <sub>rss</sub>		-	315	-	PF
Switching Characteristics (Note 4)		·				
Turn-on Delay Time	t <sub>d(on)</sub>		-	20	-	nS
Turn-on Rise Time	tr	VDD=30V,ID=2A,RL=15Ω,	-	19	-	nS
Turn-Off Delay Time	t <sub>d(off)</sub>	RG=2.5Ω,VGS=10V	-	70	-	nS
Turn-Off Fall Time	t <sub>f</sub>		-	30	-	nS
Total Gate Charge	Qg		-	125	-	nC
Gate-Source Charge	Q <sub>gs</sub>	ID=30A,VDD=30V,VGS=10V	-	24	-	nC
Gate-Drain Charge	Q <sub>gd</sub>		-	49	-	nC
Drain-Source Diode Characteristics		·				
Diode Forward Voltage (Note 3)	V <sub>SD</sub>	V <sub>GS</sub> =0V,I <sub>S</sub> =40A	-	-	1.2	V
Diode Forward Current (Note 2)	I <sub>S</sub>		-	-	105	А
Reverse Recovery Time	t <sub>rr</sub>	Tj=25℃,IF=75A,	-	37		nS
Reverse Recovery Charge	Qrr	di/dt=100A/uS (Note3)	-	58		nC
Forward Turn-On Time	t <sub>on</sub>	Intrinsic turn-on time is negligible (turn-on is dominated by LS+LD				(LS+LD)

#### Notes:

1. Repetitive Rating: Pulse width limited by maximum junction temperature.

**2.** Surface Mounted on FR4 Board, t  $\leq$  10 sec.

**3.** Pulse Test: Pulse Width  $\leq$  300µs, Duty Cycle  $\leq$  2%.

4. Guaranteed by design, not subject to production

5. EAS condition: Tj=25 $^\circ \! \mathbb{C}, V_{DD} \!=\! 40V, V_G \!=\! 10V, L \!=\! 0.5mH, Rg \!=\! 25\Omega$ 

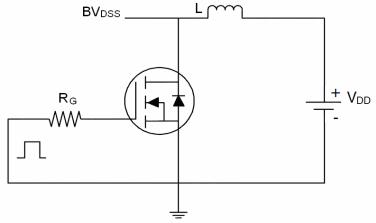


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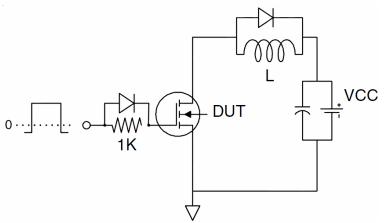


## **Test circuit**

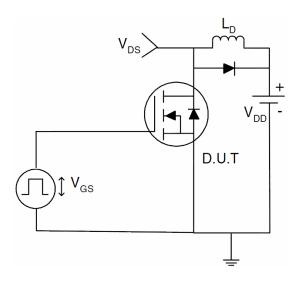
1)  $E_{AS}$  test Circuits



2) Gate charge test Circuit:



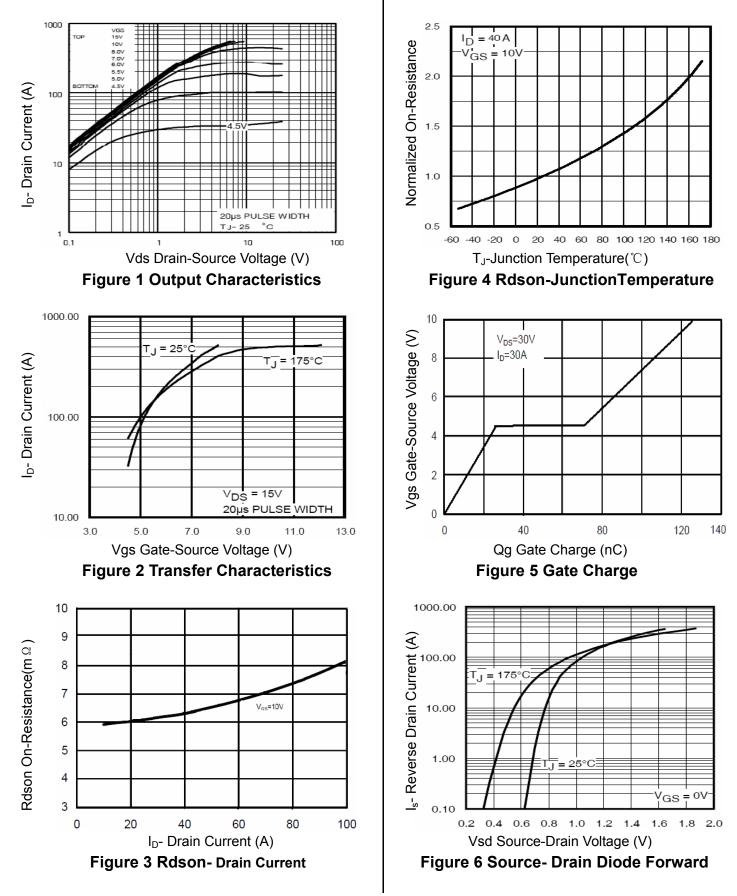
3) Switch Time Test Circuit:





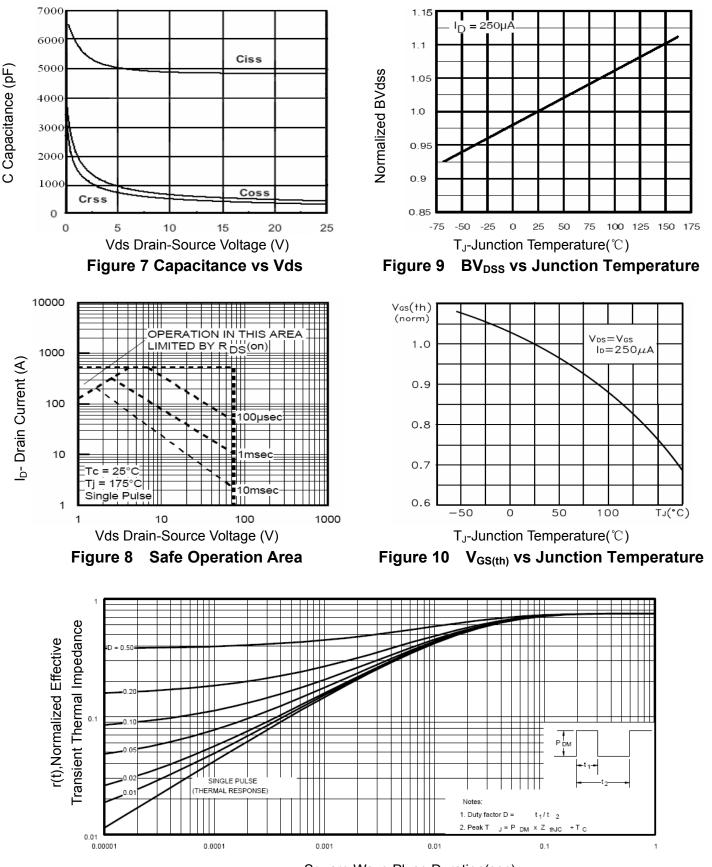
# NCE80H11D

### TYPICAL ELECTRICAL AND THERMAL CHARACTERISTICS (Curves)









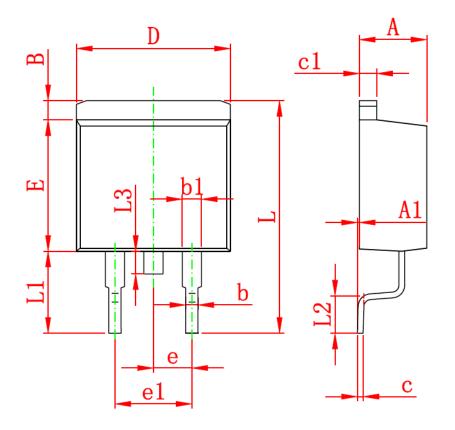
Square Wave Pluse Duration(sec)
Figure 11 Normalized Maximum Transient Thermal Impedance

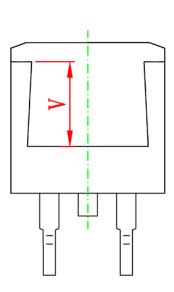




# NCE80H11D

# **TO-263-2L PACKAGE INFORMATION**





Symbol	Dimensions I	n Millimeters	<b>Dimensions In Inches</b>		
Symbol	Min	Max	Min	Max	
Α	4.470	4.670	0.176	0.184	
A1	0.000	0.150	0.000	0.006	
В	1.170	1.370	0.046	0.054	
b	0.710	0.910	0.028	0.036	
b1	1.170	1.370	0.046	0.054	
c	0.310	0.530	0.012	0.021	
c1	1.170	1.370	0.046	0.054	
D	10.010	10.310	0.394	0.406	
Е	8.500	8.900	0.335	0.350	
e	2.540 (	(TYP.)	0.100 (7	ГҮР.)	
e1	4.980	5.180	0.196	0.204	
L	15.050	15.450	0.593	0.608	
L1	5.080	5.480	0.200	0.216	
L2	2.340	2.740	0.092	0.108	
L3	1.300	1.700	0.051	0.067	
V	5.600	REF.	0.220 REF.		





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